PCN Num	ber:	201512	14003 <mark>A</mark>		P	CN Da	te: 2/10/	2016
Title:Qualification of CFAB as an additional wafer fab site option for select devices in LBC5 process technology								
Customer	Customer Contact:     PCN Manager     Dept:     Quality Services				/ices			
Proposed	1 <sup>st</sup> Ship Date	: 05/1	0/2016	Estimated Availability	Sample y:		Date prov sample re	ided at quest.
Change T	уре:							
Assembly Site Assembly P			Process		Assen	nbly Materia	ls	
Desig	n		Electrical S	Specification		Mechanical Specification		
Test S	Site		Packing/SI	hipping/Labelir	ng 📃	Test F	Process	
Wafer	Bump Site		Wafer Bun	np Material		Wafer	r Bump Proc	ess
water	Fab Site		Part numb	Materials		warer	r Fab Proces	S
Deceriptie	on of Change		PC	Details				
devices being added are shown in the Product Affected Section, Group 1. The devices previously notified are in Group 2. This change notification is to announce the qualification of CFAB as an additional wafer fab site option for the LBC5 devices listed in the product affected section of this document.								
	Curre	nt	Additional			al		
Current Site	Fab Pro	cess	Wafer Diameter	Additional Fab Site	Process	•	Wafer Diameter	
DP1DM	I5 LB	C5	200 mm	CFAB	LBC5		200 mm	1
The LBC5	process techno	logy has	been running	g successfully	in production	at CFA	AB since 201	.2.
Reason fo	or Change:							
Continuity	of Supply							
Anticipate	ed impact on	Form, Fi	t, Function,	Quality or R	eliability (p	ositive	e / negativ	e):
None								
<b>Changes</b>	to product ide	entificati	on resultin	g from this P	CN:			
Current								
Chip Site	s Chip Site	Origin Co	de (20L)	Chip Site Cour	ntry Code (21L	)	Chip Site Cit	у
DP1DM5	5	DM5		U	SA		Dallas	
New								
Chip Site	e Chip Site	Origin Co	de (20L)	Chip Site Cour	ntry Code (21L	)	Chip Site Cit	y
CFAB		CU3		CI	HN		Chengdu	
Sample product shipping label (not actual product label)								
INSTRUMENTS   G4     MADE IN: Malaysia   G4     2DC:   2C:     2D:   2C:								

Product Affected:					
Group 1: Devices Being Added in Revision A (Proposed Ship Date: 5/5/2016)					
DRV8860PW	DRV8881EPWPR	TAS5707APHPR	TAS5709APHPR		
DRV8860PWPR	DRV8881ERHRR	TAS5707LPHP	TAS5709GPHP		
DRV8860PWR	DRV8881ERHRT	TAS5707LPHPR	TAS5709GPHPR		
DRV8880PWP	DRV8881PPWP	TAS5707PHP	TAS5709PHP		
DRV8880PWPR	DRV8881PPWPR	TAS5707PHPR	TAS5709PHPR		
DRV8880RHRR	DRV8881PRHRR	TAS5709AGPHP	TAS5711PHP		
DRV8880RHRT	DRV8881PRHRT	TAS5709AGPHPR	TAS5711PHPR		
DRV8881EPWP	TAS5707APHP	TAS5709APHP	-		
Group 2: Devices previously announced (Proposed Ship Date: 3/17/2016)					
DRV8800PWP	DRV8801PWP	DRV8818PWP	DRV8818PWPR		
DRV8800PWPR	DRV8801PWPR				

# **Qualification Report**

# CFAB OFFLOAD from DMOS5 (DRV8860PWPR) Approve Date 12-Nov-2015

## **Product Attributes**

Die Attributes	Qual Device: DRV8860PWPR	QBS Product Reference: DRV8860PW	QBS Product Reference: DRV8860PWP	QBS Process Reference: TAS5613APHD
Wafer Fab Supplier	CFAB	DMO5	DM5-DALLAS	CFAB
Wafer Process	LBC5	LBC5X	LBC5X	LBC5

- QBS: Qual By Similarity - Qual Device DRV8860PWPR is qualified at LEVEL1-260CG

# **Qualification Results**

Data Displayed as: Number of lots / Total sample size / Total failed

Туре	Test Name / Condition	Duration	Qual Device: DRV8860PWPR	QBS Product Reference: DRV8860PW	QBS Product Reference: DRV8860PWP	QBS Process Reference: TAS5613APHD
AC	Autoclave 121C	96 Hours	-	-	-	3/231/0
ED	Electrical Characterization	Per Datasheet Parameters	1/30/0	1/30/0	1/30/0	1/30/0
HAST	Biased HAST, 130C/85%RH	96 Hours	-	-	-	3/231/0
HBM	ESD - HBM	4000 V	-	1/3/0	-	-
CDM	ESD - CDM	1500 V	-	1/3/0	-	-
HTOL	Life Test, 125C	1000 Hours	-	-	-	-
HTOL	Life Test, 155C	240 Hours	-	-	-	3/231/0
HTSL	High Temp. Storage Bake, 170C	420 Hours	-	-	-	3/230/0
LU	Latch-up	(per JESD78)	-	1/24/0	-	3/18/0
SBS	Ball Shear	Wires	-	-	-	-
тс	Temperature Cycle, - 65/150C	500 Cycles	-	2/154/0	1/77/0	3/231/0
TS	Thermal Shock, - 65/150C	500 Cycles	_	_	-	-

- Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

- The following are equivalent HTOL options based on an activation energy of 0.7eV: 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours

- The following are equivalent HTSL options based on an activation energy of 0.7eV : 150C/1k Hours, and 170C/420 Hours

- The following are equivalent Temp Cycle options per JESD47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles Quality and Environmental data is available at TI's external Web site: http://www.ti.com/

Green/Pb-free Status:

Qualified Pb-Free(SMT) and Green

#### **Qualification Report**

## DRV8880PWP CFAB Qual Approve Date 29-Jan-2016

#### **Product Attributes**

Attributes	Qual Device: DRV8880PWP	QBS Product Reference: DRV8880PWP	QBS Process Reference: TAS5613APHD
Wafer Fab Supplier	CFAB	DM5	CFAB
Wafer Process	LBC5	LBC5X2	LBC5

- QBS: Qual By Similarity

- Qual Device DRV8880PWP is qualified at LEVEL3-260C

## **Qualification Results**

Data Displayed as: Number of lots / Total sample size / Total failed

Туре	Test Name / Condition	Duration	Qual Device: DRV8880PWP	QBS Product Reference: DRV8880PWP	QBS Process Reference: TAS5613APHD
AC	Autoclave 121C	96 Hours	-	1/77/0	3/231/0
ED	Auto Electrical Distributions	Cpk>1.67 Room, hot, and cold test	-	-	-
ED	Electrical Characterization	Per Datasheet Parameters	Pass	Pass	Pass
ELFR	Early Life Failure Rate, 125C	48 Hours	-	-	-
HAST	Biased HAST, 130C/85%RH	96 Hours	-	-	3/231/0
HBM	ESD - HBM	4000 V	1/3/0	1/3/0	-
CDM	ESD - CDM	1500 V	1/3/0	1/3/0	-
HTOL	Life Test, 125C	1000 Hours	-	-	-
HTOL	Life Test, 155C	240 Hours	-	-	3/231/0
HTSL	High Temp. Storage Bake, 175C	500 Hours	-	-	-
HTSL	High Temp. Storage Bake, 170C	420 Hours	-	-	3/230/0
LU	Latch-up	(per JESD78)	2/12/0	1/6/0	3/18/0
тс	Temperature Cycle, - 65/150C	500 Cycles	-	1/77/0	3/231/0

- Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

- The following are equivalent HTOL options based on an activation energy of 0.7eV : 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours

- The following are equivalent HTSL options based on an activation energy of 0.7eV : 150C/1k Hours, and 170C/420 Hours

- The following are equivalent Temp Cycle options per JESD47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles

## **Qualification Report**

## Qualification of LBC5 Process Technology at CFAB Approved: 3/02/2012

## **Die Attributes**

Attributes	Process QBS : TAS5613APHD Approved: 3/2/2012	Qual Device DRV8800PWP Approved: 12/03/2015	Qual Device DRV8801PWP Approved: 12/03/2015	Qual Device DRV8818PWPR Approved 11/12/2015
Wafer Fab Site	CFAB	CFAB	CFAB	CFAB
Wafer Fab Process	LBC5	LBC5	LBC5	LBC5
Wafer Diameter	200mm	200mm	200mm	200mm

- QBS: Qual By Similarity

- Qual Device TAS5613APHD and SN8C0183PWP are qualified at LEVEL3-260C

- Qual Device DRV8800PWP/DRV8801PWP is qualified at LEVEL2-260CG

- Qual Device DRV8860PWPR is qualified at LEVEL1-260CG

## Qualification Results Data Displayed as: Number of lots / Total sample size / Total failed

	Test Name /		Process QBS Device:	Oual Device	Oual Device	Oual Device
Туре	Condition	Duration	TAS5613APHD	DRV8800PWP	DRV8801PWP	DRV8818PWPR
AC	Autoclave 121C	96 Hours	3/77/0	-	-	-
		Per				
	Electrical	Datasheet				
ED	Characterization	Parameters	3/Pass	1/Pass	3/Pass	1/Pass
	Biased HAST,					
HAST	130C/85%RH	96 Hours	3/77/0	-	-	-
HBM	ESD - HBM	1500 V	3/21/0	-	1/3/0	-
CDM	ESD - CDM	250 V	3/15/0	-	1/3/0	-
HTOL	Life Test, 155C	240 Hours	3/77/0	-	-	-
	High Temp					
UTO	Storage Bake	120.11	2 (77 / 0			
HISL	170C	420 Hours	3////0	-	-	-
LU	Latch-up	(per JESD78)	3/6/0	-	1/6/0	-
	Temperature					
TC	Cycle, -65/150C	500 Cycles	3/77/0	1/77/0	-	-

- Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

- The following are equivalent HTOL options based on an activation energy of 0.7 eV : 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours

- The following are equivalent HTSL options based on an activation energy of 0.7eV: 150C/1k Hours, and 170C/420 Hours

- The following are equivalent Temp Cycle options per JESD47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles Quality and Environmental data is available at TI's external Web site: http://www.ti.com/ **Green/Pb-free Status:** Qualified Pb-Free(SMT) and Green For questions regarding this notice, e-mails can be sent to the regional contacts shown below, or you can contact your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
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